POWERSEM

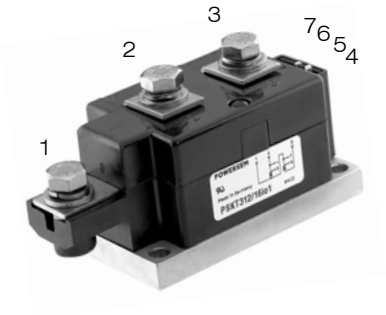
Thyristor Modules
Thyristor/Diode Modules

PSKT 255
PSKH 255

I_{TRMS} = 2x 450 A
I_{TAVM} = 2x 250 A
V_{RRM} = 1200-1800 V

Preliminary Data Sheet

V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V	Type	
1300	**1200**	**PSKT 255-12io1**	**PSKH 255-12io1**
1500	**1400**	**PSKT 255-14io1**	**PSKH 255-14io1**
1700	**1600**	**PSKT 255-16io1**	**PSKH 255-16io1**
1900	**1800**	**PSKT 255-18io1**	**PSKH 255-18io1**



Symbol	Test Conditions		Maximum Ratings	
I_{TRMS}, I_{FRMS}	$T_{VJ} = T_{VJM}$		450	A
I_{TAVM}, I_{FAVM}	T_C = 85°C; 180° sine		250	A
I_{TSM}, I_{FSM}	T_{VJ} = 45°C;	t = 10 ms (50 Hz)	9000	A
	V_R = 0	t = 8.3 ms (60 Hz)	9600	A
	$T_{VJ} = T_{VJM}$	t = 10 ms (50 Hz)	7800	A
	V_R = 0	t = 8.3 ms (60 Hz)	8600	A
$\int i^2dt$	T_{VJ} = 45°C	t = 10 ms (50 Hz)	405 000	A^2s
	V_R = 0	t = 8.3 ms (60 Hz)	382 000	A^2s
	$T_{VJ} = T_{VJM}$	t = 10 ms (50 Hz)	304 000	A^2s
	V_R = 0	t = 8.3 ms (60 Hz)	307 000	A^2s
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$; f =50 Hz, t_P =200 µs; V_D = 2/3 V_{DRM}; I_G = 1 A, di_G/dt = 1 A/µs	repetitive, I_T = 860 A	100	A/µs
		non repetitive, $I_T = I_{TAVM}$	500	A/µs
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$; V_{DR} = 2/3 V_{DRM}; R_{GK} = ∞; method 1 (linear voltage rise)		1000	V/µs
P_{GM}	$T_{VJ} = T_{VJM}$	t_P = 30 µs	120	W
	$I_T = I_{TAVM}$	t_P = 500 µs	60	W
P_{GAV}			20	W
V_{RGM}			10	V
T_{VJ}			-40...+130	°C
T_{VJM}			130	°C
T_{stg}			-40...+125	°C
V_{ISOL}	50/60 Hz, RMS	t = 1 min	3000	V~
	$I_{ISOL} \leq$ 1 mA	t = 1 s	3600	V~
M_d	Mounting torque (M6)		4.5-7/40-62	Nm/lb.in.
	Terminal connection torque (M8)		11-13/97-115	Nm/lb.in.
Weight	Typical including screws		750	g

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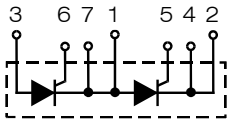

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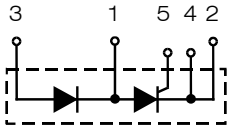

Features
- International standard package
- Direct copper bonded Al_2O_3-ceramic with copper base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered E 148688
- Keyed gate/cathode twin pins

Applications
- Motor control, softstarter
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Solid state switches

Advantages
- Simple mounting
- Improved temperature and power cycling capability
- Reduced protection circuits

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

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Symbol	Test Conditions		Characteristic Values	
I_{RRM}, I_{DRM}	$T_{VJ} = T_{VJM}$; $V_R = V_{RRM}$; $V_D = V_{DRM}$		40	mA
V_T, V_F	I_T, I_F = 600 A; T_{VJ} = 25°C		1.36	V
V_{T0}	For power-loss calculations only (T_{VJ} = 130°C)		0.8	V
r_T			0.68	mΩ
V_{GT}	V_D = 6 V;	T_{VJ} = 25°C	2	V
		T_{VJ} = -40°C	3	V
I_{GT}	V_D = 6 V;	T_{VJ} = 25°C	150	mA
		T_{VJ} = -40°C	220	mA
V_{GD}	$T_{VJ} = T_{VJM}$;	V_D = 2/3 V_{DRM}	0.25	V
I_{GD}	$T_{VJ} = T_{VJM}$;	V_D = 2/3 V_{DRM}	10	mA
I_L	T_{VJ} = 25°C; t_P = 30 µs; V_D = 6 V I_G = 0.45 A; di_G/dt = 0.45 A/µs		200	mA
I_H	T_{VJ} = 25°C; V_D = 6 V; R_{GK} = ∞		150	mA
t_{gd}	T_{VJ} = 25°C; V_D = 1/2 V_{DRM} I_G = 1 A; di_G/dt = 1 A/µs		2	µs
t_q	$T_{VJ} = T_{VJM}$; I_T = 300 A, t_P = 200 µs; -di/dt = 10 A/µs V_R = 100 V; dv/dt = 50 V/µs; V_D = 2/3 V_{DRM}	typ.	200	µs
Q_S	T_{VJ} = 125°C; I_T, I_F = 300 A; -di/dt = 50 A/µs		760	µC
I_{RM}			275	A
R_{thJC}	per thyristor (diode); DC current	other values see Fig. 8/9	0.140	K/W
	per module		0.07	K/W
R_{thJK}	per thyristor (diode); DC current		0.18	K/W
	per module		0.09	K/W
d_S	Creeping distance on surface		12.7	mm
d_A	Creepage distance in air		9.6	mm
a	Maximum allowable acceleration		50	m/s^2

Optional accessories for modules
Keyed Gate/Cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

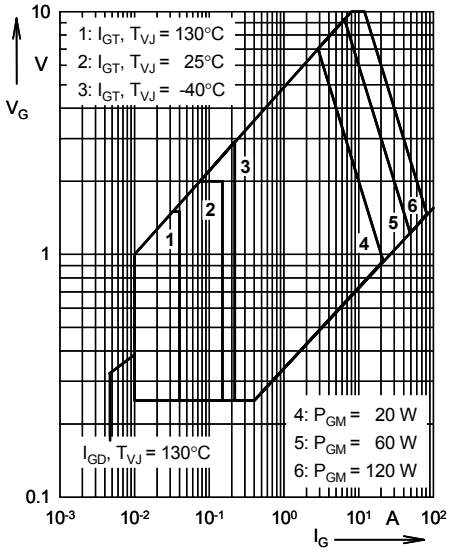

Fig. 1 Gate trigger characteristics

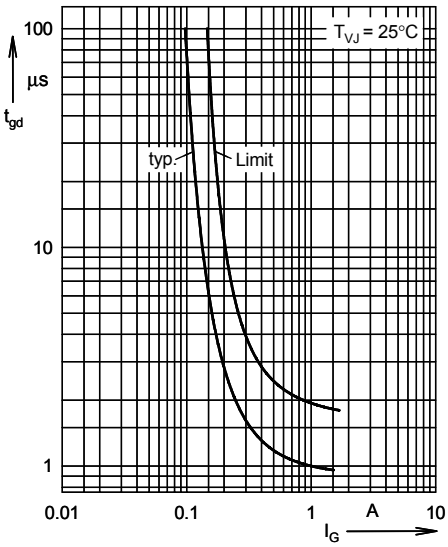

Fig. 2 Gate trigger delay time

Dimensions in mm (1 mm = 0.0394")

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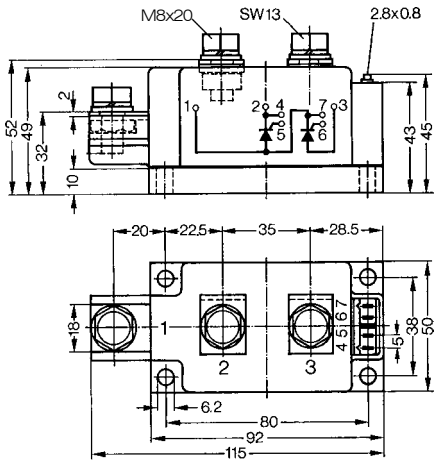

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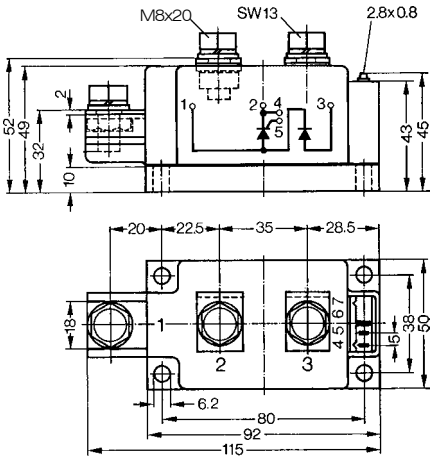

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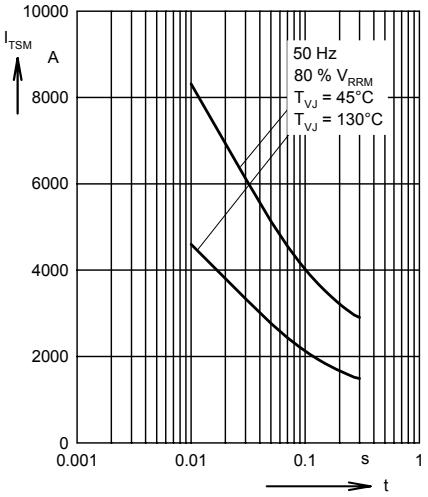

Fig. 3 Surge overload current
I_{TSM}, I_{FSM}: Crest value, t: duration

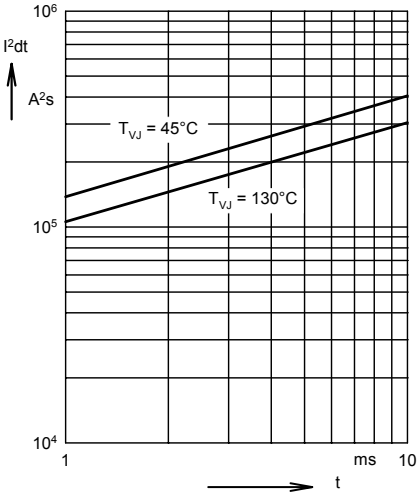

Fig. 4 ∫i²dt versus time (1-10 ms)

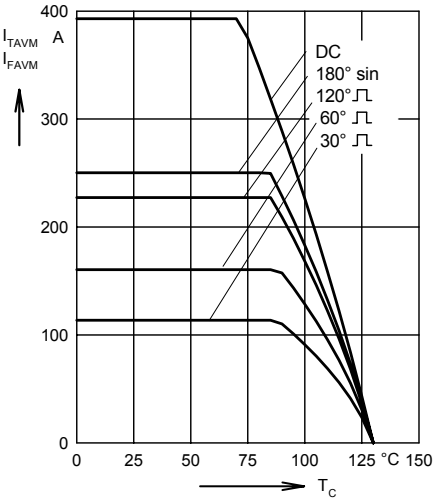

Fig. 4a Maximum forward current at case temperature

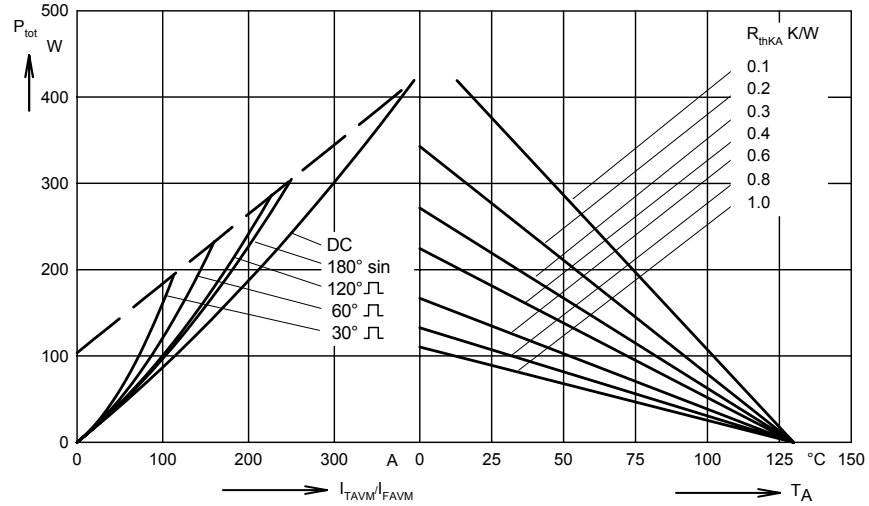

Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

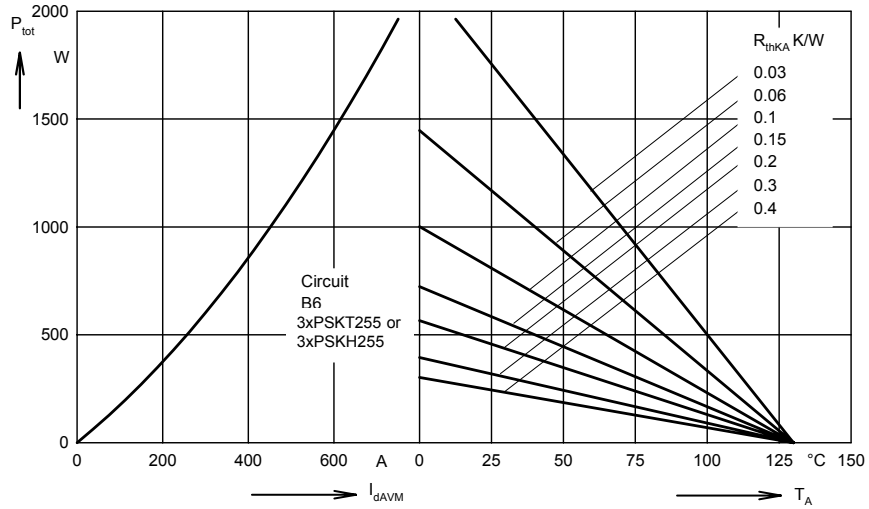

Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

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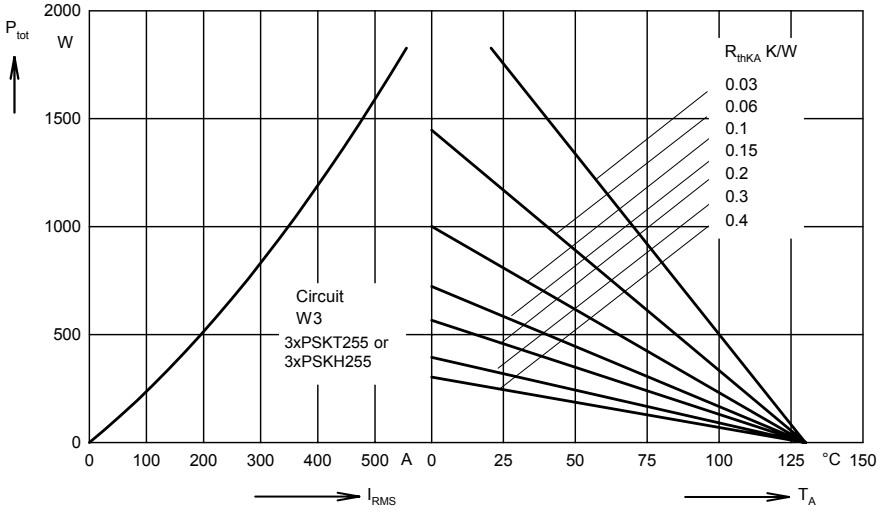

Fig. 7 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

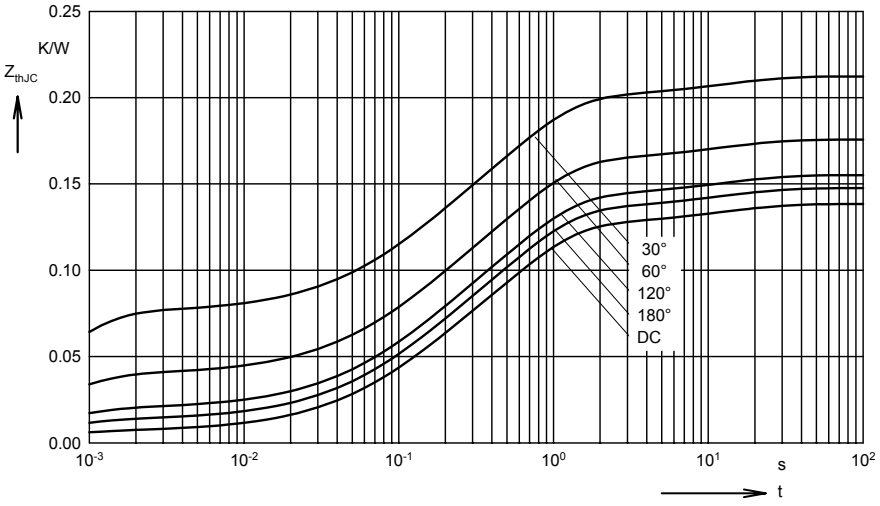

Fig. 8 Transient thermal impedance junction to case (per thyristor or diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} (K/W)
DC	0.139
180°	0.148
120°	0.156
60°	0.176
30°	0.214

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.00054
2	0.0358	0.098
3	0.0831	0.54
4	0.0129	12

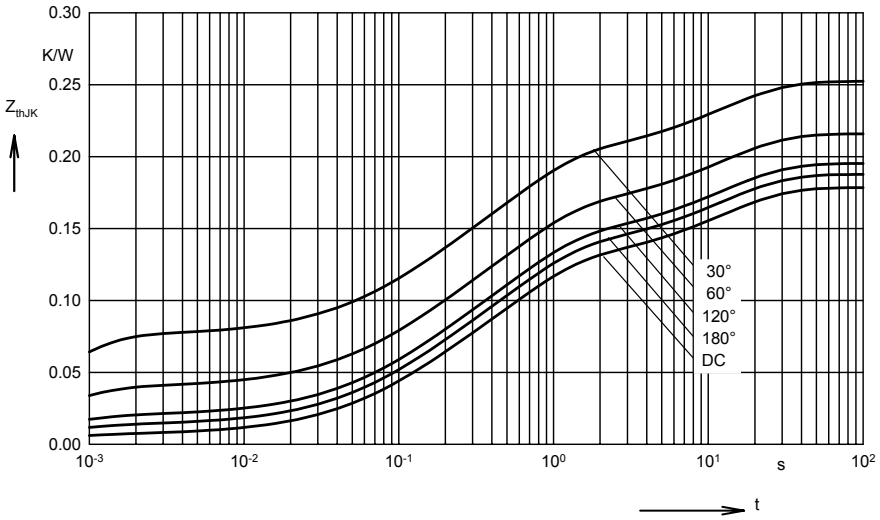

Fig. 9 Transient thermal impedance junction to heatsink (per thyristor or diode)

R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.179
180°	0.188
120°	0.196
60°	0.216
30°	0.254

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0066	0.00054
2	0.0358	0.098
3	0.0831	0.54
4	0.0129	12
5	0.04	12

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